

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT										
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Masahiro MIURA</td> <td>09/13/2008</td> </tr> <tr> <td>Tetsuya SATOH</td> <td>09/13/2008</td> </tr> <tr> <td>Hiroyuki WATANABE</td> <td>09/13/2008</td> </tr> <tr> <td>Masato UEDA</td> <td>09/24/2008</td> </tr> </tbody> </table>		Name	Execution Date	Masahiro MIURA	09/13/2008	Tetsuya SATOH	09/13/2008	Hiroyuki WATANABE	09/13/2008	Masato UEDA	09/24/2008
Name	Execution Date										
Masahiro MIURA	09/13/2008										
Tetsuya SATOH	09/13/2008										
Hiroyuki WATANABE	09/13/2008										
Masato UEDA	09/24/2008										
<b>RECEIVING PARTY DATA</b>											
<b>Name:</b>	SUMITOMO CHEMICAL COMPANY, LIMITED										
<b>Street Address:</b>	27-1, Shinkawa 2-chome,										
<b>City:</b>	Chuo-ku, Tokyo										
<b>State/Country:</b>	JAPAN										
<b>Postal Code:</b>	104-8260										
<b>PROPERTY NUMBERS Total: 1</b>											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12282071</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12282071						
Property Type	Number										
Application Number:	12282071										
<b>CORRESPONDENCE DATA</b>											
<b>Fax Number:</b>	(202)293-7860										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
<b>Phone:</b>	2022937060										
<b>Email:</b>	sslater@sughrue.com										
<b>Correspondent Name:</b>	John Callahan (Sughrue Mion)										
<b>Address Line 1:</b>	2100 Pennsylvania Avenue, N.W.										
<b>Address Line 2:</b>	Suite 800										
<b>Address Line 4:</b>	Washington, DISTRICT OF COLUMBIA 20037										
<b>ATTORNEY DOCKET NUMBER:</b>	Q109983(JTC)										
<b>NAME OF SUBMITTER:</b>	John Callahan										
Total Attachments: 2											

**CH \$40.00 12282071**

**500686652**

**PATENT  
 REEL: 021738 FRAME: 0941**

source=Q109983assignment#page1.tif  
source=Q109983assignment#page2.tif

**ASSIGNMENT**

Whereas, I/we,

<u>Name</u>	<u>Address</u>
1) <b>Masahiro MIURA</b>	c/o Osaka University, 1-1, Yamadaoka, Suita-shi, Osaka 565-0871 Japan
2) <b>Tetsuya SATOH</b>	c/o Osaka University, 1-1, Yamadaoka, Suita-shi, Osaka 565-0871 Japan
3) <b>Hiroyuki WATANABE</b>	c/o Osaka University, 1-1, Yamadaoka, Suita-shi, Osaka 565-0871 Japan
4) <b>Masato UEDA</b>	2-8-39, Higashi, Tsukuba-shi, Ibaraki 305-0046 Japan

hereinafter called assignor(s), have invented certain improvements in  
**FUSED RING COMPOUND AND METHOD FOR PRODUCING SAME, POLYMER, ORGANIC THIN FILM CONTAINING THOSE, AND ORGANIC THIN FILM DEVICE AND ORGANIC THIN FILM TRANSISTOR COMPRISING SUCH ORGANIC THIN FILM**

and executed an application for Letters Patent of the United States of America therefor on even date herewith unless otherwise indicated below:

filed on September 8, 2008, Serial No. 12/282071; and

Whereas

**SUMITOMO CHEMICAL COMPANY, LIMITED**  
 27-1, Shinkawa 2-chome,  
 Chuo-ku, Tokyo 104-8260 Japan

(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor;

NOW THEREFORE, be it known that, for good and valuable consideration from assignee, the receipt of which is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

INVENTORSDATE SIGNED

1): Name: _____	<i>Masahiro Miura</i> <b>Masahiro MIURA</b>	_____	<i>Sep. 13, 2008</i>
2): Name: _____	<i>Tetsuya Satoh</i> <b>Tetsuya SATOH</b>	_____	<i>Sep 13, 2008</i>
3): Name: _____	<i>Hiroyuki Watanabe</i> <b>Hiroyuki WATANABE</b>	_____	<i>Sep. 13, 2008</i>
4): Name: _____	<b>Masato UEDA</b>	_____	

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261)

